

Dual 1 Form A/B, C Solid State Relay

Features

- Current Limit Protection
- Isolation Test Voltage 3750 V_{RMS}
- Typical R_{ON} 10 Ω
- Load Voltage 200 V
- Load Current 200 mA
- High Surge Capability
- Linear, AC/DC Operation
- Clean Bounce Free Switching
- Low Power Consumption
- SMD Lead Available on Tape and Reel

Agency Approvals

- UL - File No. E52744
- CSA - Certification 093751
- BSI

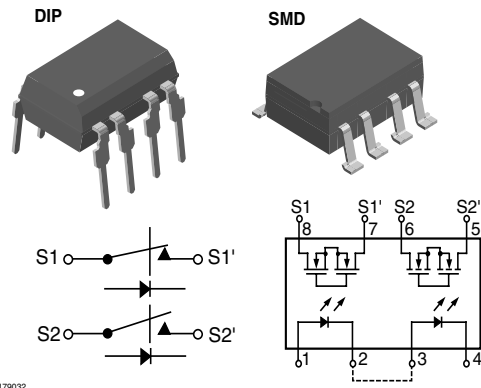
Applications

General Telecom Switching

- On/off Hook Control
- Ring Delay
- Dial Pulse
- Ground Start
- Ground Fault Protection

Instrumentation

Industrial Controls



Description

The LH1512 relays contain normally open and normally closed switches that can be used independently as a 1 Form A and 1 Form B relay, or when used together, as a 1 Form C relay. The relays are constructed as a mult.- chip hybrid device. Actuation control is via an Infrared LED. The output switch is a combination of a photodiode array with MOSFET switches and control circuitry.

Order Information

Part	Remarks
LH1512BAC	Tubes, SMD-8
LH1512BACTR	Tape and Reel, SMD-8
LH1512BB	Tubes, DIP-8

Absolute Maximum Ratings, $T_{amb} = 25\text{ }^{\circ}\text{C}$

Stresses in excess of the absolute Maximum Ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute Maximum Ratings for extended periods of time can adversely affect reliability.

SSR

Parameter	Test condition	Symbol	Value	Unit
LED continuous forward current		I_F	50	mA
LED reverse voltage	$I_R \leq 10\text{ }\mu\text{A}$	V_R	5.0	V
DC or peak AC load voltage	$I_L \leq 50\text{ }\mu\text{A}$	V_L	200	V
Continuous DC load current (Form C operation)		I_L	200	mA
Peak load current, Form A	$t = 100\text{ ms}$	I_P	2)	
Peak load current (single shot) Form B		I_P	400	mA
Ambient operating temperature range		T_{amb}	- 40 to + 85	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	- 40 to + 125	$^{\circ}\text{C}$
Pin soldering temperature	$t = 10\text{ s max}$	T_{sld}	260	$^{\circ}\text{C}$
Input/output isolation test voltage	$t = 1.0\text{ s, } I_{ISO} = 10\text{ }\mu\text{A max}$	V_{ISO}	3750	V_{RMS}
Pole-to-pole isolation voltage (S1 to S2) ¹⁾ (dry air, dust free, at sea level)			1600	V
Output power dissipation (continuous)		P_{diss}	600	mW

¹⁾ Breakdown occurs between the output pins external to the package.

²⁾ Refer to Current Limit Performance Application Note for a discussion on relay operation during transient currents.

Electrical Characteristics, $T_{amb} = 25\text{ }^{\circ}\text{C}$

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

Input

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
LED forward current for switch turn-on (NO)	$I_L = 100\text{ mA, } t = 10\text{ ms}$	I_{Fon}		0.6	2.0	mA
LED forward current for switch turn-off (NO)	$V_L = \pm 150\text{ V}$	I_{Foff}	0.2	0.5		mA
LED forward current for switch turn-on (NC)	$I_L = 100\text{ mA, } t = 10\text{ ms}$	I_{Fon}	0.2	0.9		mA
LED forward current for switch turn-off (NC)	$V_L = \pm 150\text{ V}$	I_{Foff}		1.0	2.0	mA
LED forward voltage	$I_F = 10\text{ mA}$	V_F	1.15	1.26	1.45	V

Output

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
ON-resistance: (NO, NC)	$I_F = 5.0\text{ mA (NO), } I_F = 0\text{ mA (NC), } I_L = 50\text{ mA (NC)}$	R_{ON}		10	15	Ω
OFF-resistance: (NO)	$I_F = 0\text{ mA, } V_L = \pm 100\text{ V}$	R_{OFF}	0.35	5000		$G\Omega$
OFF-resistance: (NC)	$I_F = 5.0\text{ mA, } V_L = \pm 100\text{ V}$	R_{OFF}	0.1	1.4		$G\Omega$

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Current limit: (NO)	$I_F = 5.0 \text{ mA}$, $t = 5.0 \text{ ms}$, $V_L = \pm 5.0 \text{ V}$	I_{LMT}	270	360	460	mA
Off-state leakage current: (NO)	$I_F = 0 \text{ mA}$, $V_L = \pm 100 \text{ V}$			0.02	1000	nA
Off-state leakage current: (NC)	$I_F = 5.0 \text{ mA}$, $V_L = \pm 100 \text{ V}$			0.07	1.0	μA
Off-state leakage current: (NO, NC)	$I_F = 0 \text{ mA (NO)}$, $I_F = 5.0 \text{ mA}$, $V_L = \pm 200 \text{ V}$				1.0	μA
Output capacitance: (NO)	$I_F = 0 \text{ mA}$, $V_L = 50 \text{ V}$			60		
Output capacitance: (NC)	$I_F = 5.0 \text{ mA}$, $V_L = 50 \text{ V}$			60		

Transfer

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Capacitance (input-output)	$V_{ISO} = 1.0 \text{ V}$	C_{IO}		3.0		pF
Turn-on time (NO)	$I_F = 10 \text{ mA}$, $I_L = 50 \text{ mA}$	t_{on}		1.4	3.0	ms
Turn-on time (NC)	$I_F = 10 \text{ mA}$, $I_L = 50 \text{ mA}$	t_{on}		1.2	3.0	ms
Turn-off time (NO)	$I_F = 10 \text{ mA}$, $I_L = 50 \text{ mA}$	t_{off}		0.7	3.0	ms
Turn-off time (NC)	$I_F = 10 \text{ mA}$, $I_L = 50 \text{ mA}$	t_{off}		2.0	3.0	ms

Typical Characteristics ($T_{amb} = 25 \text{ }^\circ\text{C}$ unless otherwise specified)

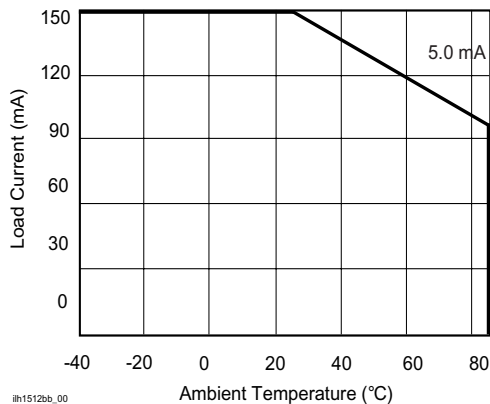


Fig. 1 Recommended Operating Conditions

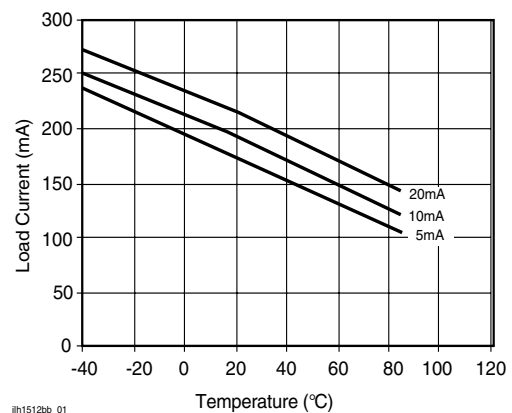


Fig. 2 Form A_Typical Load Current vs. Temperature

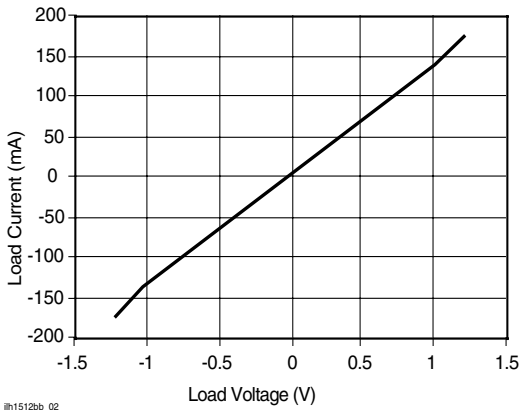


Fig. 3 Form A_Typical Load Current vs. Load Voltage

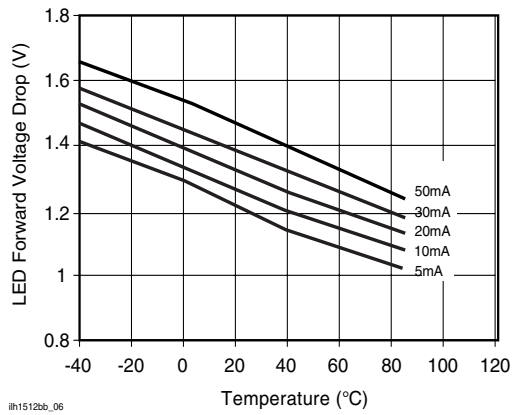


Fig. 6 Typical LED Forward Voltage Drop vs. Temperature

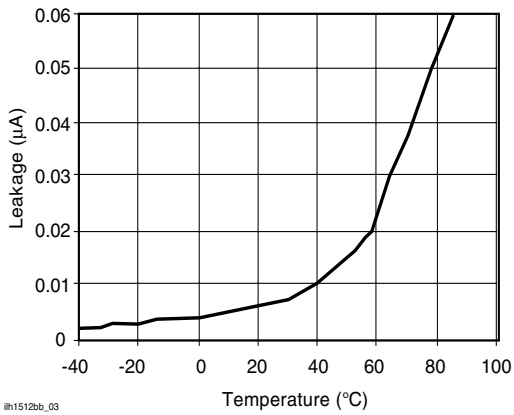


Fig. 4 Typical Leakage vs. Temperature
(Measured across Pin 5&6 or 7&8)

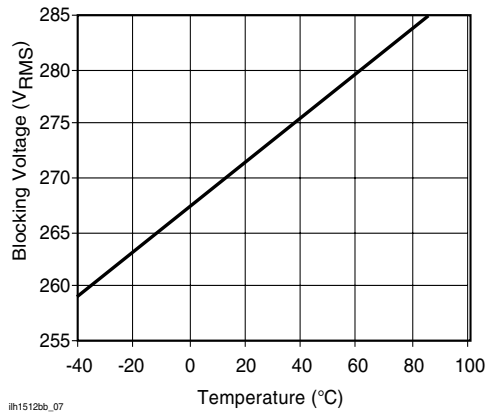


Fig. 7 Form A_Typical Blocking Voltage vs. Temperature

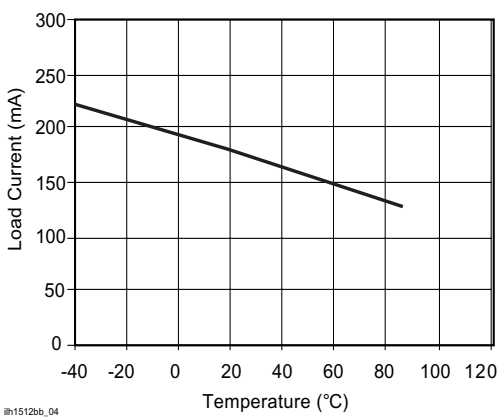


Fig. 5 Form B_Typical Load Current vs. Temperature

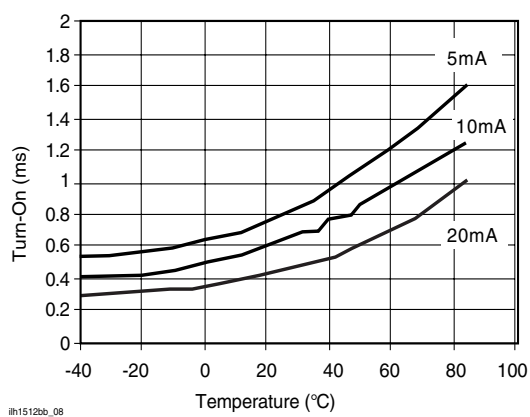


Fig. 8 Form A_Typical Turn-On vs. Temperature

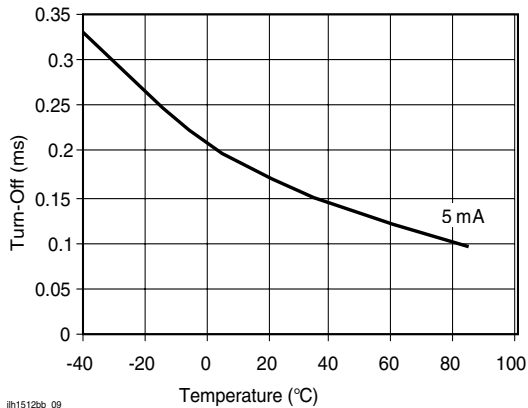


Fig. 9 Form A_Typical Turn-Off vs. Temperature

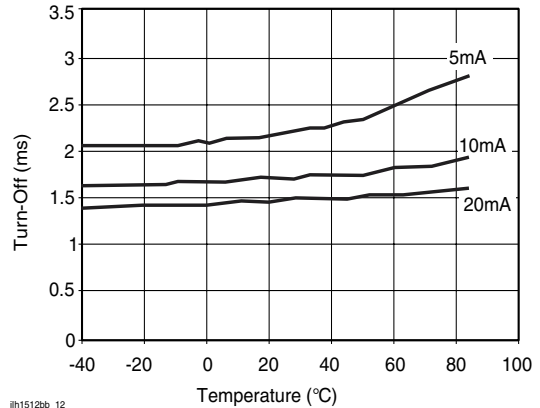


Fig. 12 Form B_Typical Turn-Off vs. Temperature

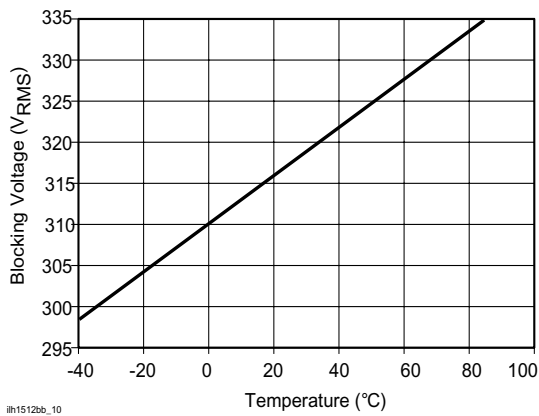


Fig. 10 Form B_Typical Blocking Voltage vs. Temperature

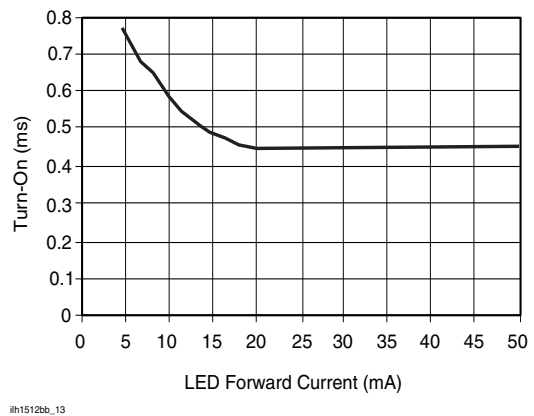


Fig. 13 Form A_Typical Turn-On vs. LED Forward Current

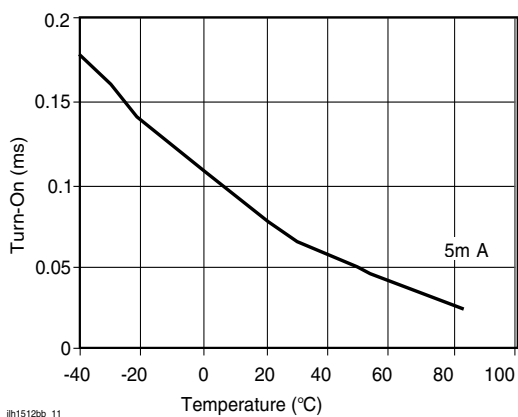


Fig. 11 Form B_Typical Turn-On vs. Temperature

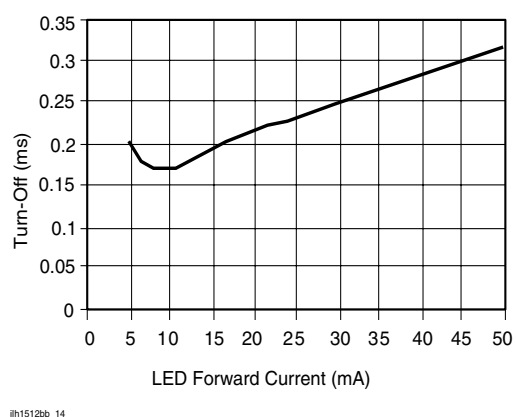


Fig. 14 Form A_Typical Turn-Off vs. LED Forward Current

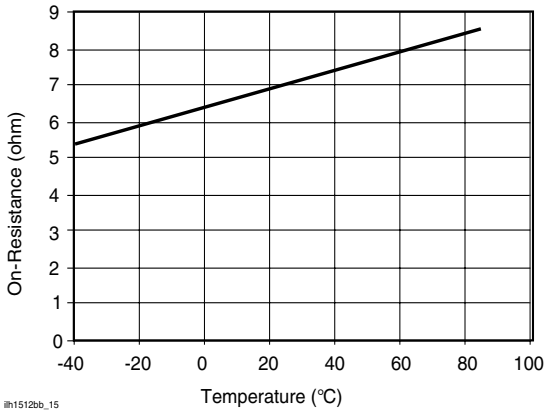


Fig. 15 Form A Typical On-Resistance vs. Temperature

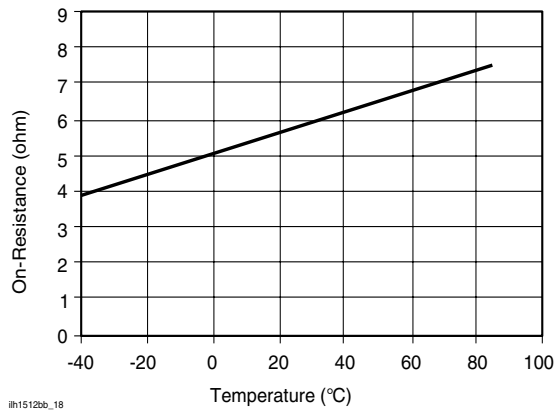


Fig. 18 Form B Typical On-Resistance vs. Temperature

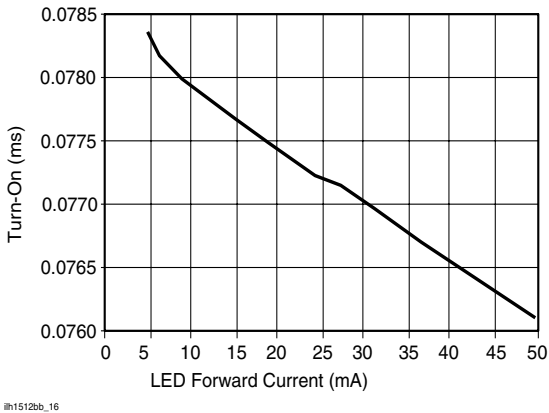


Fig. 16 Form B Typical Turn-On vs. LED Forward Current

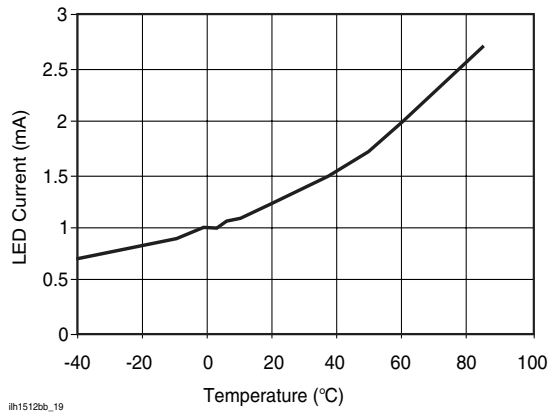


Fig. 19 Form A Typical I_F for Switch Operation vs. Temperature

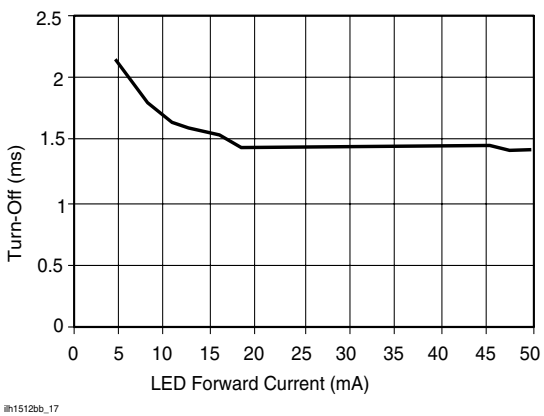


Fig. 17 Form B Typical Turn-Off vs. LED Forward Current

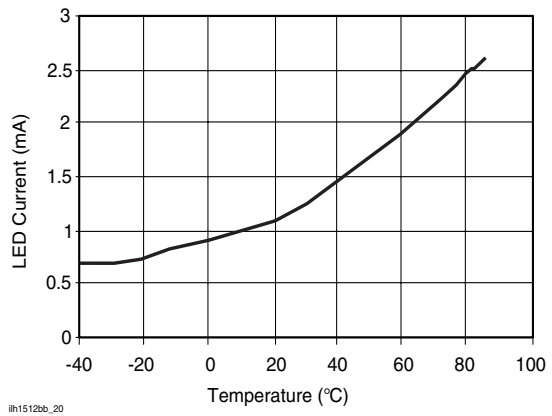
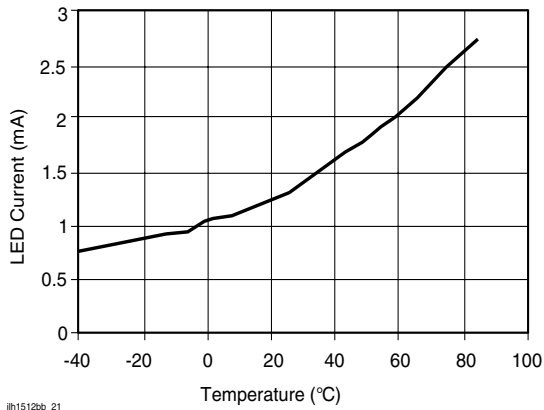
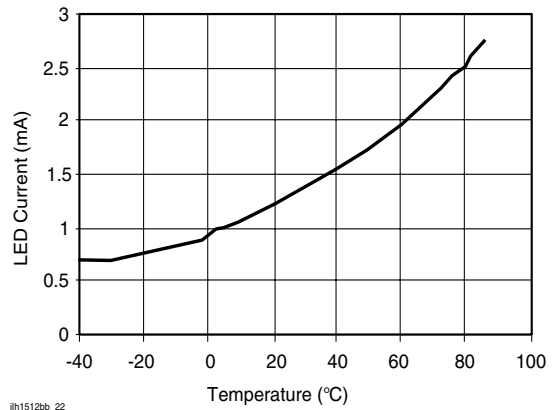


Fig. 20 Form A Typical I_F for Switch Dropout vs. Temperature



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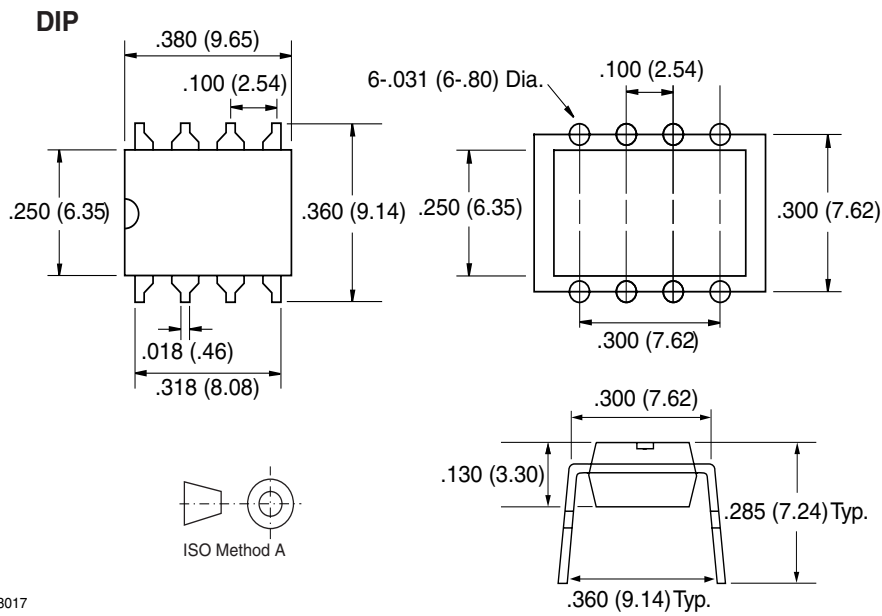
Fig. 21 Form B_Typical I_F for Switch Operation vs. Temperature



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Fig. 22 Form B_Typical I_F for Switch Dropout vs. Temperature

Package Dimensions in Inches (mm)



i178017

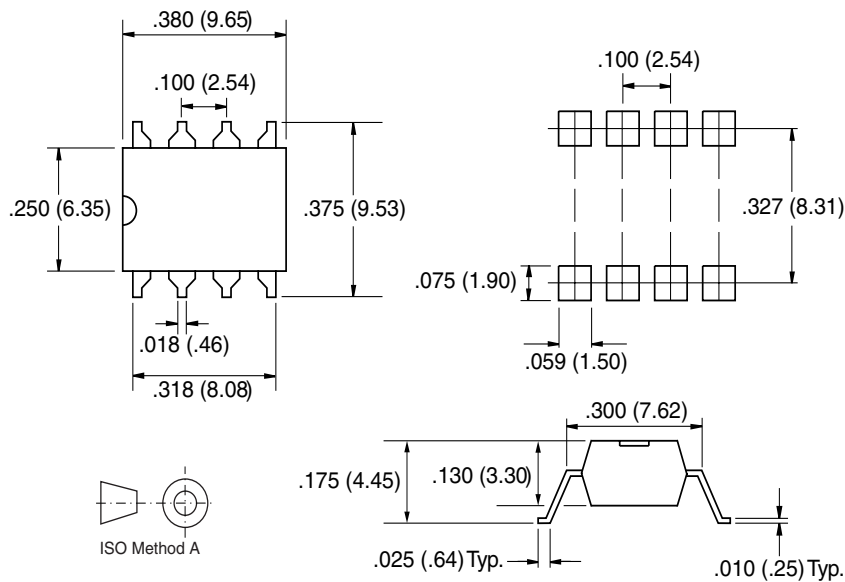
LH1512BAC/ BACTR/ BB



Vishay Semiconductors

Package Dimensions in Inches (mm)

SMD





Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

**We reserve the right to make changes to improve technical design
and may do so without further notice.**

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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